

Preface

Dear Distinguished Authors and Guests,

It's a great pleasure to present papers from the 8th International Conference on Advanced Materials and Engineering Materials (ICAMEM 2019) which was held in Hong Kong, China 18-19 April 2019.

Since the first ICAMEM in Shenyang, China (2011), a series of ICAMEM has been held in Asia: the 2nd, Beijing and Shanghai, China (2012); the 3rd, Singapore (2013); the 4th, Ningbo and Hong Kong, China (2014); the 5th, Hong Kong (2016); the 6th, Singapore (2017) and the 7th, Bangkok, Thailand (2018).

The aim of 8th ICAMEM2019 was to gather professors, researchers and scholars all over the world. ICAMEM2019 will provide leading academy and industry scientists a platform to communicate recent advances in Advanced Materials Science, Engineering Materials Research and an opportunity to establish multilateral collaborations.

The papers were selected after the peer-review process by conference committee members and international reviewers. The submitted papers were selected on the basis of originality, significance, and clarity for the purpose of the conference.

On behalf of the organizing committee, the editor would like to acknowledge the technical comments from the reviewers and thank all of the authors for their contributions to this proceeding book.

With our warmest regards,

Conference Organizing Chair
Prof. Peng-Sheng Wei
National Sun Yat-Sen University, Kaohsiung, Taiwan
May 4, 2019

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Summer Wang, X-academy

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